

Automotive Product Division STMicroelectronics









Agenda 2

- Automotive Industry Transformation
- Technology Drivers
- Architecture Evolution
- Advanced Processing Demand



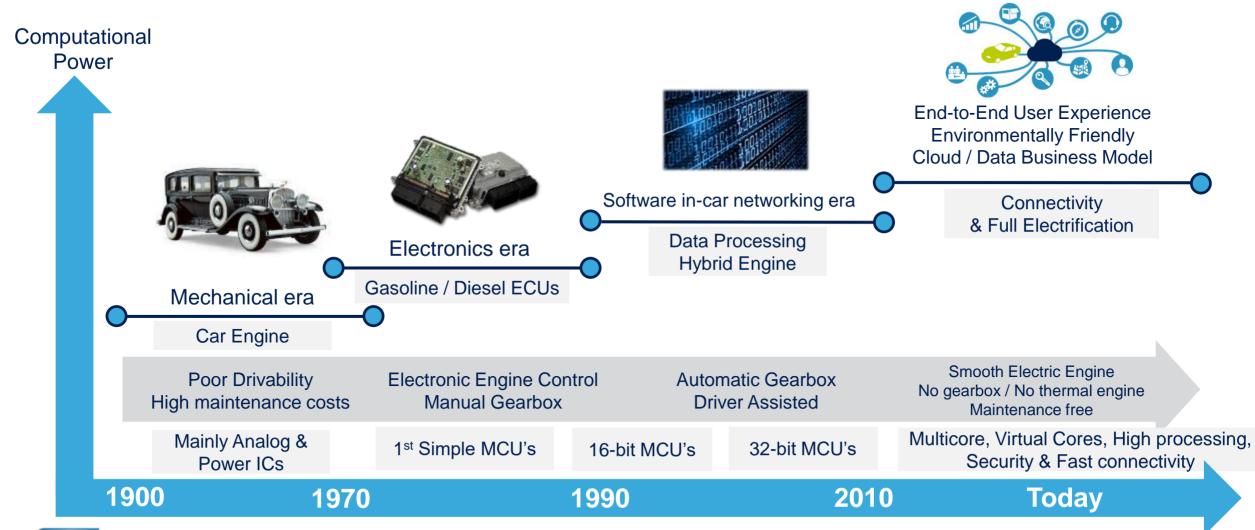
Agenda 3

- Automotive Industry Transformation
- Technology Drivers
- Architecture Evolution
- Advanced Processing Demand



Automotive Industry Transformation

From Simple Mechanics to Complex Electronics





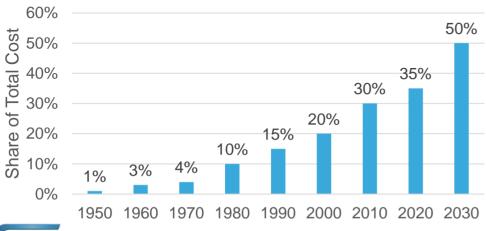
Today's Automotive System

70-90 ECUs on average

Application Segmentation

- 8-12 communication buses
- Various communication protocols
 - CAN
 - LIN
 - Ethernet
 - Flexray ...

Growth Automotive ECU Cost







Source: Statista

Previous & Current Architectures

Topology and Key Properties

Legacy Network Each ECU serves specific Distributed / modular flat function architecture Application-specific buses Dominated by classic CAN * and many 1-to-1 direct Low protection level communication links Gateway integrated into CAN, LIN, FlexRay, MOST **BCM** CAN MOST

Current Network Basic functional integration . Introduction of OTA Multiple network interfaces . Application-specific buses and multiple 1-to-1 direct More function-specific communication links **ECUs** CAN FD, LIN, FlexRay, Security becomes crutial Ethernet 100Mb/s **Central Gateway** CAN FLEXRAY



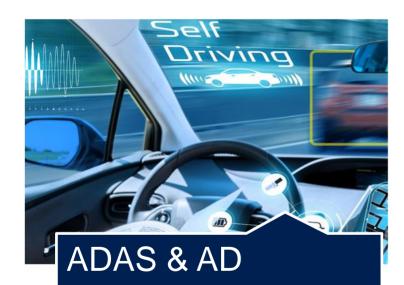
Agenda 7

- Automotive Industry Transformation
- Technology Drivers
- Architecture Evolution
- Advanced Processing Demand



Technology Drivers

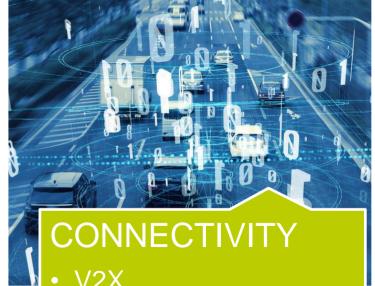
Major Trends



- Sensor fusion
- Safety & security
- Artificial intelligence



Cost optimization

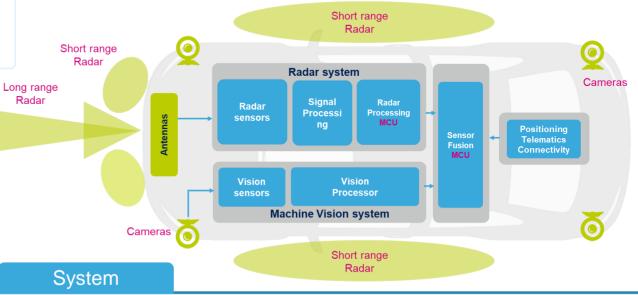


- V2X
- Cloud computing
- Media streaming
- Over-The-Air



ADAS / AD

System, Trends, and Challenges



- ADAS: Camera, Radar, and LiDAR coupled with V2X, Telematics, and GNSS
- AD: Higher level of autonomy and controllability

Trends

- ADAS value per vehicle will grow from \$160 to \$512
- Silicon content will grow with automation level

Challenges

- Higher level of integration
- Centralized decision making
- Safety pushed to the next level "Fail-Operational"
- Improved reaction time
- Security becomes a top safety priority





Source: Strategy Analytics

Electrification

System, Trends, and Challenges

PHEV and BEV only

Charging

Charging

System

 Hybrid Electric Vehicle (HEV): engine plus motor (small motor/battery)
 Plug-in Hybrid Electric Vehicle (PHEV):

HEV plus charger (medium motor/battery)

Battery Electric Vehicle (BEV):

PHEV minus engine (large motor/battery)

Trends

EVs will cost same as non-EVs by 2025
 EVs sales will surpass non-EVs by 2038

DC-DC HV

 Converts DC from the high voltage batteries (400V-700V) to a DC voltage required by the traction inverter

Battery management Systems (BMS)

 Manages the batteries for longevity and performance

DC-DC 12 V

 Converts HV DC from the HV batteries to 12 V for use in legacy vehicle subsystems

Traction Inverter

 Converts DC Voltage into 3-phase AC at up to 200kW for the electric motor

On-Board Charger (OBC)

 Converts AC from the Grid 95-265 V_{ac} and converts to a DC voltage required for battery charging 400-800 V

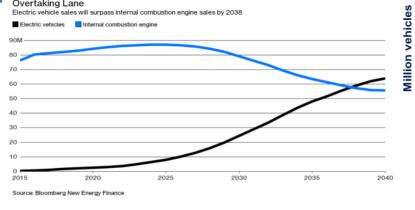
DC-DC 48 V

 Converts HV DC from the HV batteries to 48 V for use in vehicle subsystems

Challenges

- Functional integration of multiple applications
- Higher safety
- Standardization
- Cost improvement
- Modular power architecture







Source: Bloomberg New Energy Finance

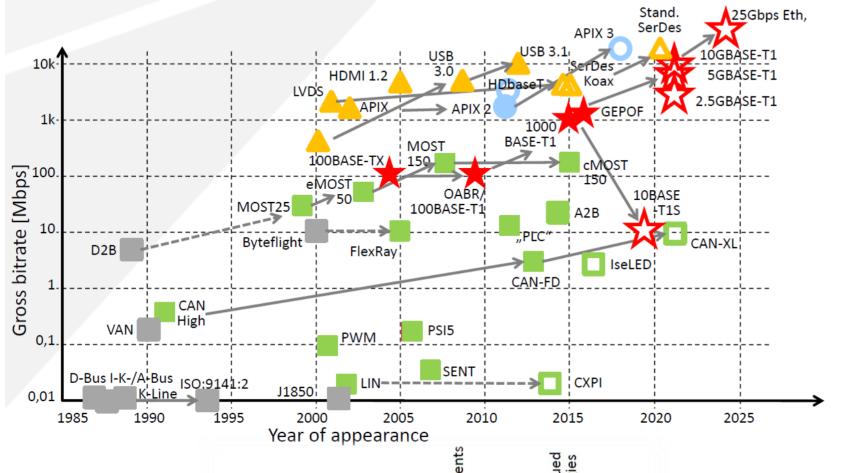
Stand. 25Gbps Eth, SerDes APIX 3 USB 3.1 USB 3.0 10GBASE-T1 10k

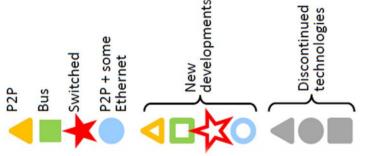
Connectivity

Trends and Challenges

Challenges

- Higher bandwidth
- Cybersecurity
- SW and HW Standardization
- Data
- Virtualization
- Low latency
- OTA
- Adaptive Autosar / service oriented





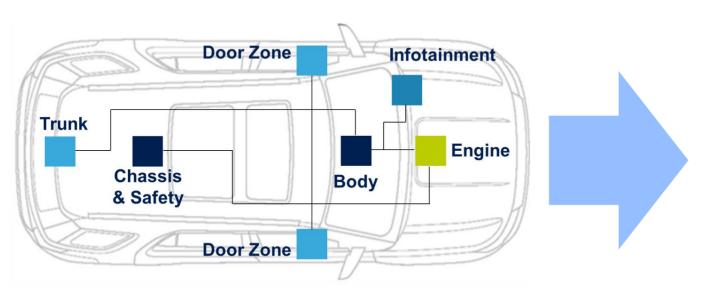


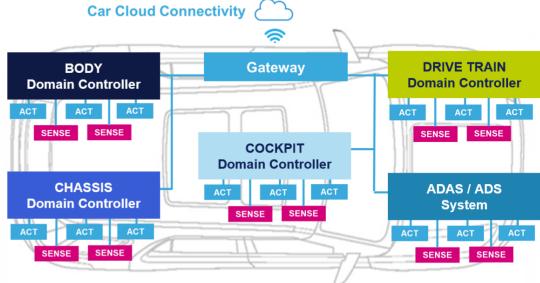
- Automotive Industry Transformation
- Technology Drivers
- Architecture Evolution
- Advanced Processing Demand



Architecture Evolotion

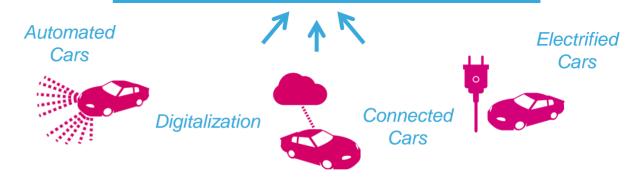
Functional Consolidation



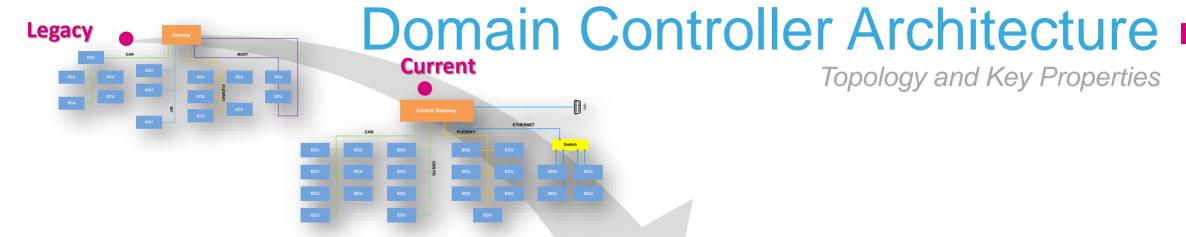


- Introduction of Gateways between traditional ECUs of associated domain and backbone
- Protocol translation between signal-based and service oriented domains with inner and cross domain communications
- Centralization and integration of related SW
 functionalities

New Car Digital Architecture

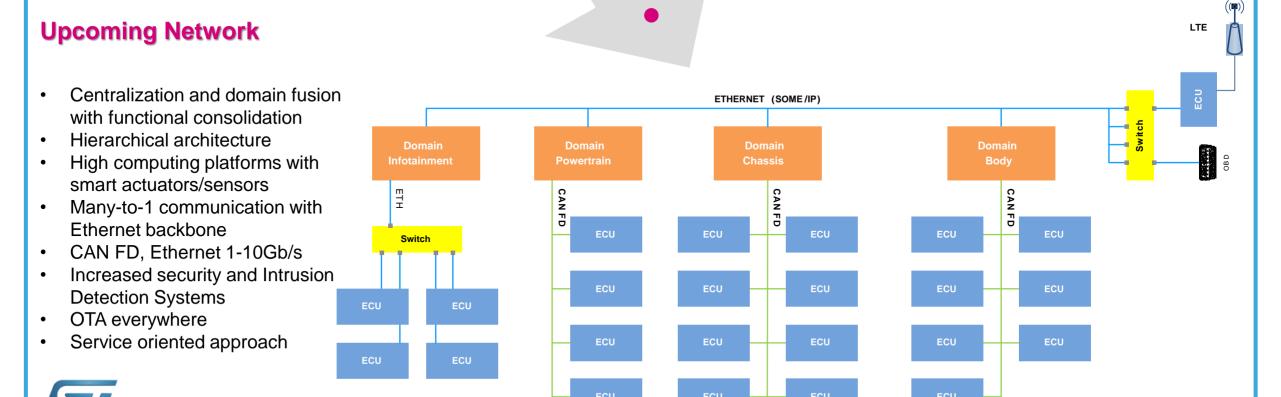






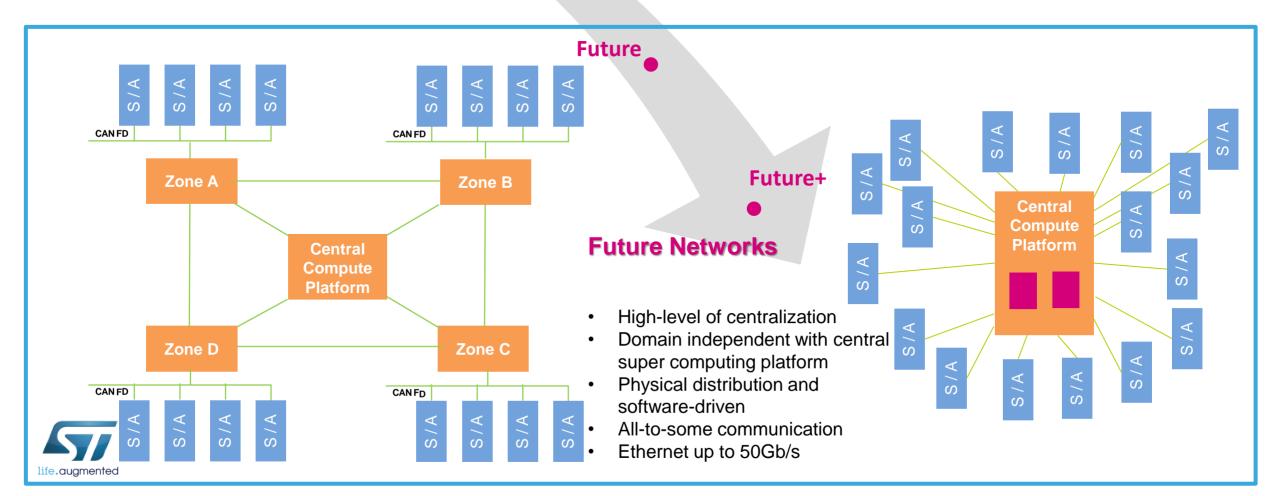
life.augmented

Topology and Key Properties



Future Architectures 15 Legacy **Current** Topology and Key Properties

Upcoming

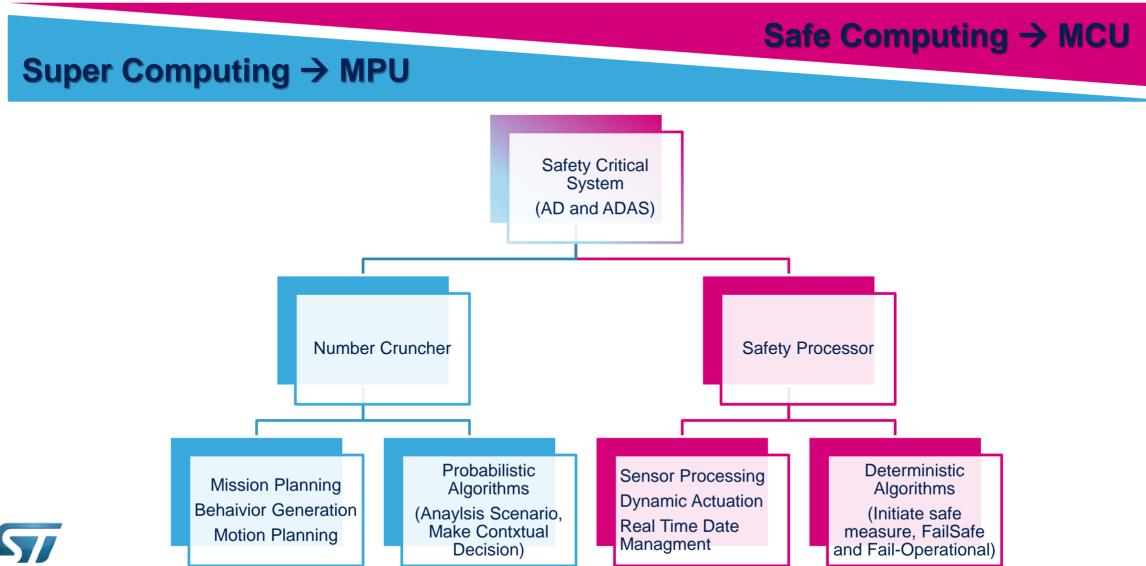


- Automotive Industry Transformation
- Technology Drivers
- Architecture Evolution
- Advanced Processing Demand



Advanced Processing Demand

Computing and Safety Requirements





Impact on MCU Design

Key Influncers



CAN / ETH Routing & Inspection

- Routing performance
- Packet inspection
- Software overload
- New protocols

Real Time Behavior

- Start-up / power-down
- Reaction time
- Accelerators

Over The-Air

- Hardware support
- Rollback functionality
- External Memory interfaces
- Secure boot

Virtualization

- HW hypervisor
- Real-time, determistic behvior

Safety & Security

- ASIL-D support
- HW self-test
- HSM subsytsem
- Memory protection
- Communication secuirty

Low Power Modes

- Standby/Stop operations
- Smart wakeup unit

STELLAR MCU Family

Unique Solution in 28nm eNVM Technology Paradigm



Unprecedented
Safe & Secure
Real-time
Performance

v. real-time Virtualization
ie. Multi Update-able
Applications Platform
(turn-key for DCUs)

STELLAR Real-Time
HW Virtualization Architecture built on

most powerful real-time CPU

only real-time CPU w.
 HW virtualization



arm CORTEX®-R52

ARM real-time CPU

Embedded NVM

Phase Change Memory



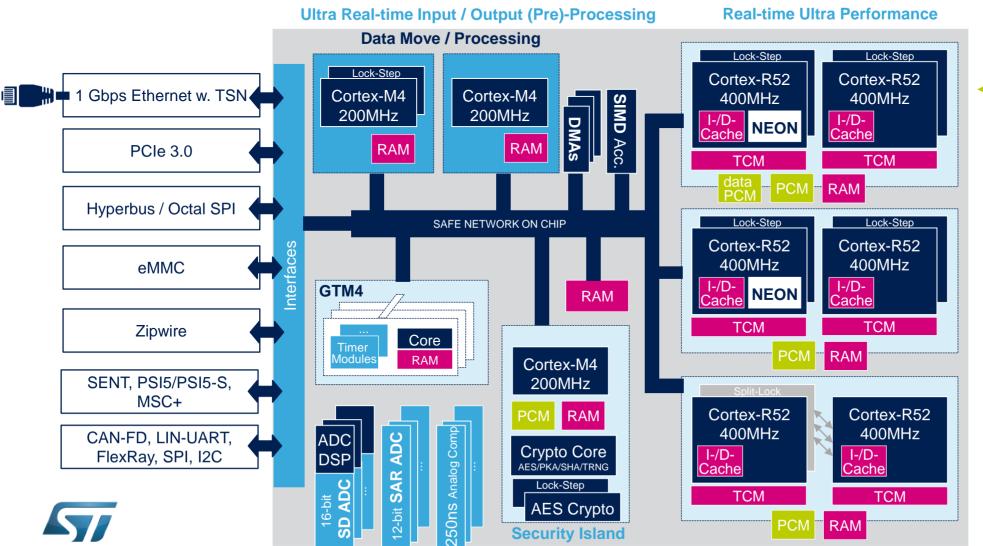






STELLAR MCU Family

Processing Architecture - Heterogeneous Multiprocessor





Memory

- Up to 20M PCM
- Up to 8.5M RAM

M4 Subsystems Use Cases

- Safe Data Router
- Safe / QM Input/Ouput Data Processing & Move for Higher Level Proc. or Output
- Security Subsystem



Contact

Khaldoun Albarazi

Market Development Engineer Automotive Product Division STMicroelectronics

Khaldoun.Albarazi@st.com



Thank You!